Form PTO-1449 U.S. Department of Commerce (REV. 2-82) Patent and Trademark Office								Atty. Docket No.A35953 Serial No. (Not Yet Assigned) 072595.0231 Serial No. (Not Yet Assigned)				
INFORMATION DISCLOSURE STATEMENT BY APPLICANT							TATEMENT	Applicant Nozaki Katsumasa				
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nm		Patent Abstracts of Japan, Publication No. 11-307711 dated 05.11/1999, Application No. 11-052362 dated 01.03.1999, Applicant-Samsung Aerospace Ind Ltd., Inventors: Boku Seitetsu, Ri Keikan, Kin Chuho, Kyo Seinichi, Shin Toitsu and Cho Baijun for LEAD FRAME FOR SEMICONDUCTOR PACKAGE, AND LEAD FRAME PLATING METHOD										
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Examiner	M.Y	new	V4 #	א סו			Date	Considered 7/15/04				

^{*} Examiner: Initial citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not conformance and not considered. Include copy of this form with next communication to applicant.